

FDY6342L Integrated Load Switch

Features

- Max $r_{DS(on)} = 0.5 \Omega$ at $V_{GS} = 4.5 V$, $I_D = -0.83 A$
- Max $r_{DS(on)} = 0.7 \Omega$ at $V_{GS} = 2.5 V$, $I_D = -0.70 A$
- Max r_{DS(on)} = 1.2 Ω at V_{GS} = 1.8 V, I_D = -0.43 A
- Max r_{DS(on)} = 1.8 Ω at V_{GS} = 1.5 V, I_D = -0.36 A
- Control MOSFET (Q1) includes Zener protection for ESD ruggedness (>4 kV Human body model)
- High performance trench technology for extremely low r_{DS(on)}
- Compact industry standard SC89-6 surface mount package
- RoHS Compliant



General Description

This device is particularly suited for compact power management in portable electronic equipment where 2.5 V to 8 V input and 0.83 A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) that drives a large P-Channel power MOSFET (Q2) in one tiny SC89-6 package.

Applications

- Power management
- Load switch



See Application Circuit

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{IN}	Gate to Source Voltage (Q2)		±8	V	
V _{ON/OFF}	Gate to Source Voltage (Q1)		-0.5 to 8	V	
ILoad	Load Current -Continuous	(Note 2)	-0.83	^	
	-Pulsed	(Note 2)	-1.0	— A	
D	Power Dissipation	(Note 1a)	0.625	14/	
P _D	Power Dissipation	(Note 1b)	0.446	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	200	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	280	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
Н	FDY6342L	SC89-6	7 "	8 mm	3000 units

1

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BVIN	V _{IN} Breakdown Voltage	$I_D = -250 \ \mu A$, $V_{ON/OFF} = 0 \ V$	8			V
I _{Load}	Zero Gate Voltage Drain Current	$V_{IN} = -6.4 \text{ V}, V_{ON/OFF} = 0 \text{ V}$			-1	μΑ
I _{FL}	Leakage Current, Forward	$V_{IN} = 8 V, V_{ON/OFF} = 0 V$			10	μA
I _{RL}	Leakage Current, Reverse	$V_{IN} = -8 V, V_{ON/OFF} = 0 V$			-10	μA
	cteristics (note 2)		1	1		T
V _{ON/OFF(th)}	Gate Threshold Voltage	$V_{IN} = V_{ON/OFF}$, $I_D = -250 \ \mu A$	0.65	0.85	1.5	V
r _{DS(on)}		$V_{IN} = 4.5 \text{ V}, I_D = -0.83 \text{ A}$		0.28	0.5	
	Static Drain to Source On Resistance (Q2)	$V_{IN} = 2.5 V, I_D = -0.70 A$		0.35	0.7	Ω
		V _{IN} = 1.8 V, I _D = -0.43 A		0.45	1.2	
r _{DS(on)}				0.57	1.8	
r _{DS(on)}		V _{IN} = 1.5 V, I _D = -0.36 A		0.57	1.0	
r _{DS(on)}	Static Drain to Source On Resistance (Q1)	$V_{IN} = 1.5 \text{ V}, I_D = -0.36 \text{ A}$ $V_{IN} = 4.5 \text{ V}, I_D = 0.4 \text{ A}$		2.9	4.0	Ω

Drain-Source Diode Characteristics

I _S	Maximum Continuous Drain to Source Diode Forward Current			-0.25	V
V _{SD}	Source to Drain Diode Forward Voltage $$V_{\rm ON}$$	_{I/OFF} = 0 V, I _S = -0.25 A (Note 2)	-0.8	-1.2	V

NOTES:

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design.



a)200 ^oC/W when mounted on a 1 in² pad of 2 oz copper.

b)280 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 µs, Duty cycle < 2.0%.

FDY6342L Load Switch Application circuit



External Component Recommendation:

For additional in-rush current control, R2 and C1 can be added. For more information, see application note AN1030



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